



SPP9517

P-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPP9517 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

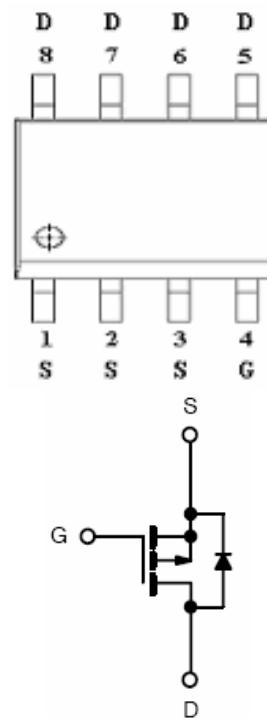
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

FEATURES

- ◆ -40V/-10A,RDS(ON)= 16mΩ@VGS=- 10V
- ◆ -40V/- 8A,RDS(ON)= 22mΩ@VGS=- 4.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOP – 8P package design

PIN CONFIGURATION(SOP – 8P)



PART MARKING



A : Lot Code
B : Date Code



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PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP9517S8RGB	SOP- 8P	SPP9517

※ SPP9517S8RGB 13" Tape Reel ; Pb – Free ; Halogen – Free

ABSOLUTLE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-40	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	ID	-10
	T _A =70°C		-8
Pulsed Drain Current	I _{DM}	-30	A
Continuous Source Current(Diode Conduction)	I _S	-2.3	A
Power Dissipation	T _A =25°C	P _D	2.8
	T _A =70°C		1.8
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	70	°C/W



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ELECTRICAL CHARACTERISTICS

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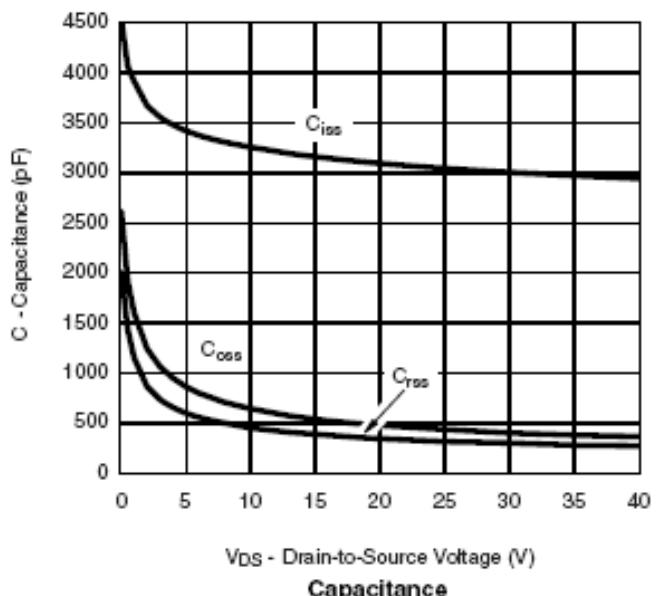
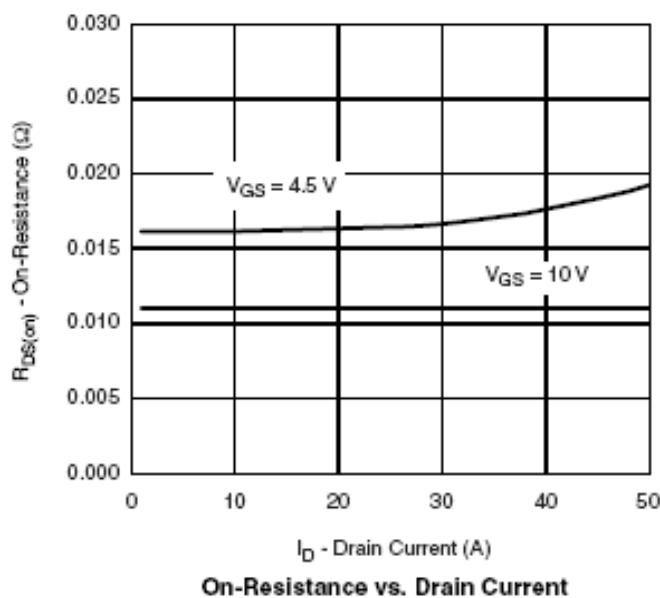
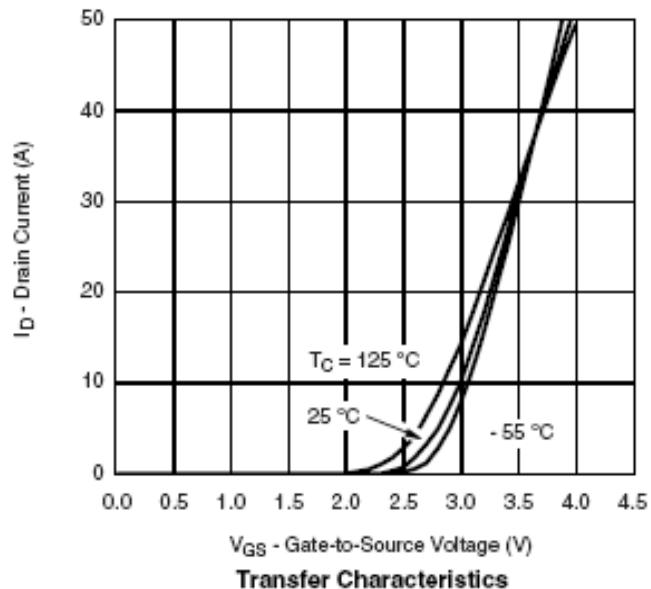
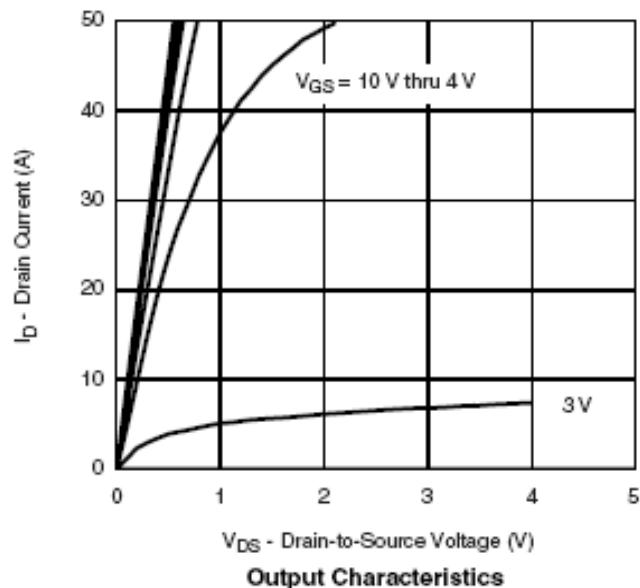
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=-250uA	-40			V
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=-250uA	-0.8		-2.5	
Gate Leakage Current	IGSS	VDS=0V, VGS=±20V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=-36V, VGS=0V			-1	uA
		VDS=-36V, VGS=0V TJ=85°C			-10	
On-State Drain Current	ID(on)	VDS= -5V, VGS =-4.5V	-10			A
Drain-Source On-Resistance	RDS(on)	VGS=-10V, ID=-10A		0.012	0.016	Ω
		VGS=-4.5V, ID=- 8A		0.017	0.022	
Forward Transconductance	gfs	VDS=-15V, ID=-5.7A		13		S
Diode Forward Voltage	VSD	IS=-2.3A, VGS =0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Qg	VDS=-15V, VGS=-5.0V ID= -10.0A		40	55	nC
Gate-Source Charge	Qgs			10		
Gate-Drain Charge	Qgd			14		
Input Capacitance	Ciss	VDS=-20V, VGS=0V f=1MHz		2300		pF
Output Capacitance	Coss			280		
Reverse Transfer Capacitance	Crss			240		
Turn-On Time	td(on)	VDD=-15V, RL=15Ω ID=-1.0A, VGEN=-10.0V RG=6Ω		20	25	nS
	tr			15	25	
Turn-Off Time	td(off)			60	90	
	tf			40	60	



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TYPICAL CHARACTERISTICS

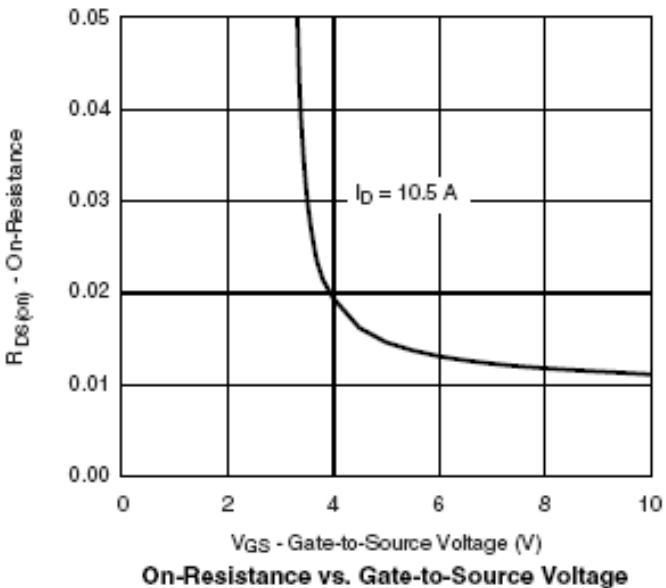
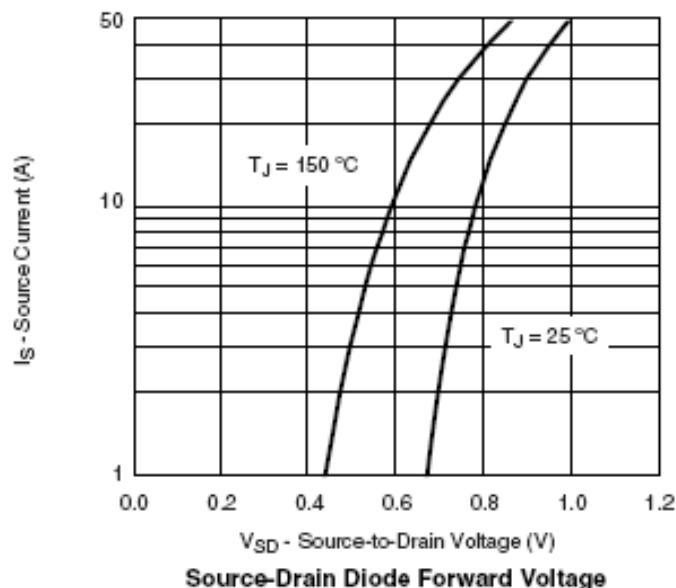
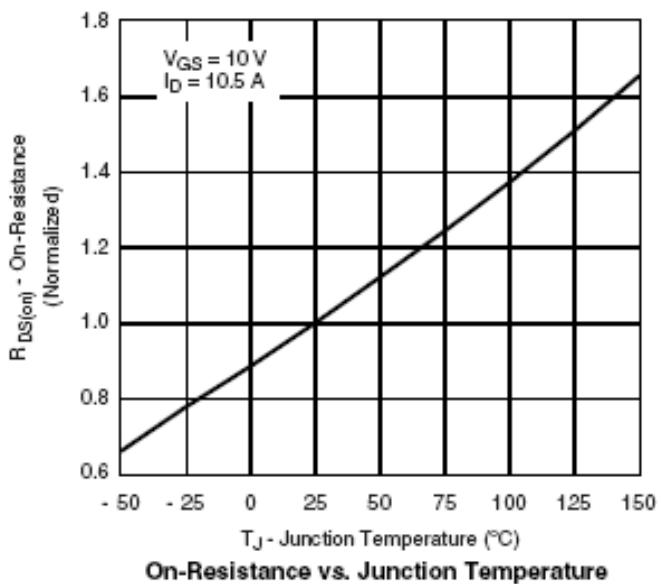
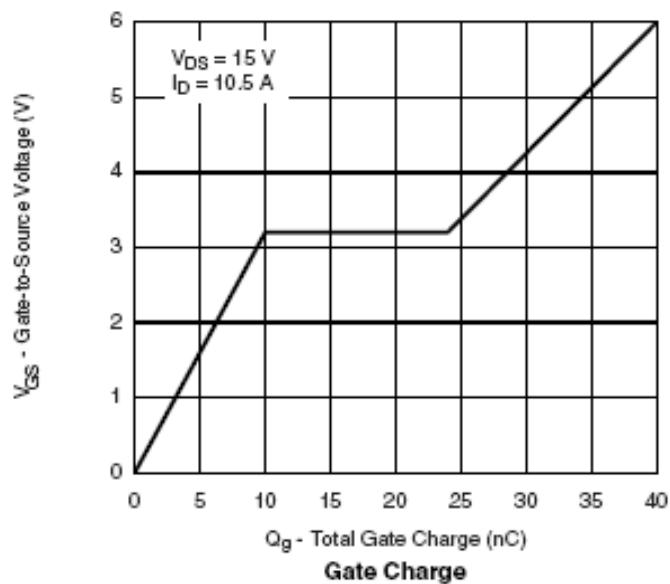




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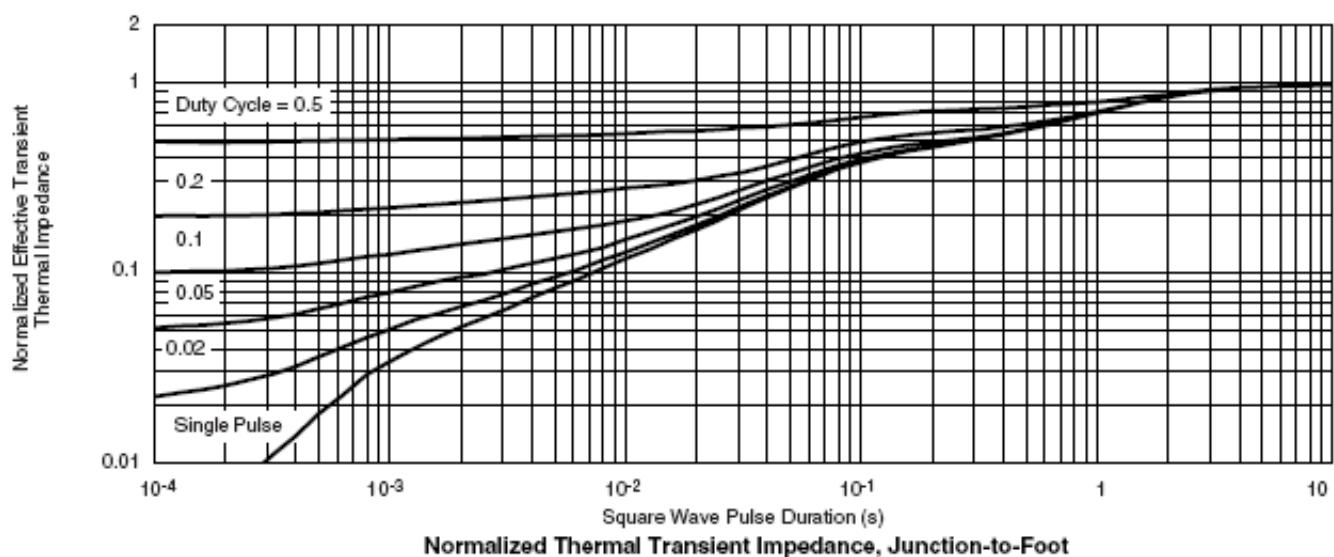
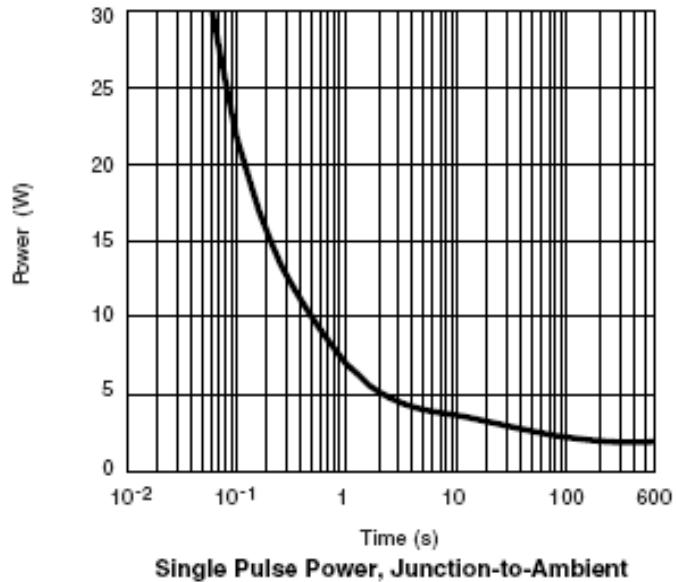
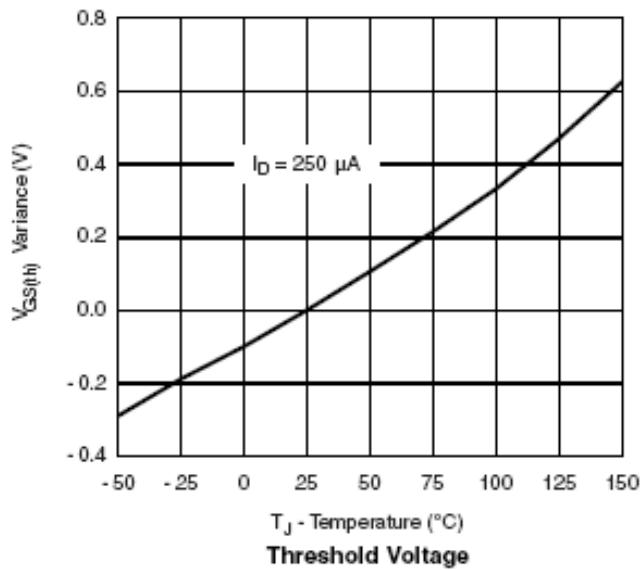




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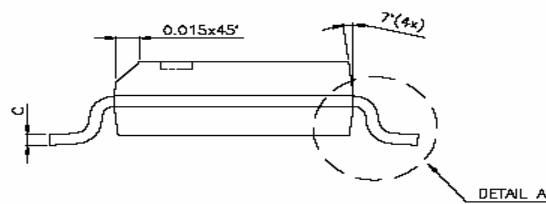
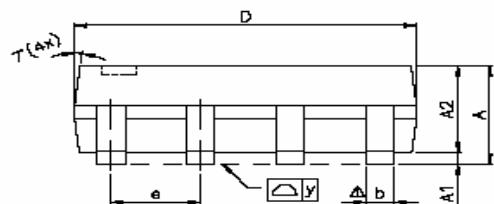
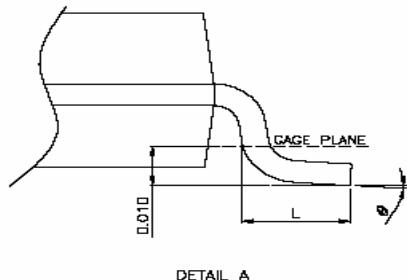
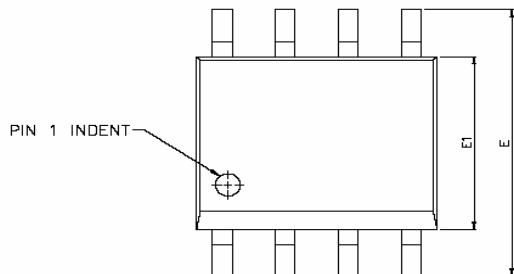




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SOP- 8 PACKAGE OUTLINE



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10	—	0.25	0.004	—	0.010
A2	—	1.45	—	—	0.057	—
b	0.33	0.41	0.51	0.013	0.016	0.020
C	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	—	1.27	—	—	0.050	—
L	0.38	0.71	1.27	0.015	0.028	0.050
\triangle_y	—	—	0.076	—	—	0.003
θ	0°	—	8°	0°	—	8°



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